Alfa-MOS Technology

AFC3366W
40V N & P Pair Enhancement Mode MOSFET

General Description

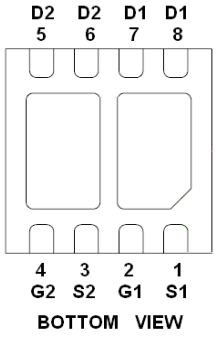
AFC3366W, N & P Pair enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent RDS(ON), low gate charge.
These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

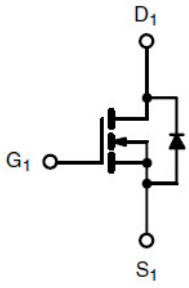
Features

N-Channel
- 60V/12A,$R_{DS(ON)}$=48mΩ@V_{GS}=10V
- 60V/10A,$R_{DS(ON)}$=54mΩ@V_{GS}=4.5V

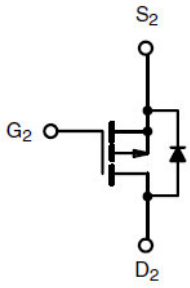
P-Channel
- -60V/-8A,$R_{DS(ON)}$= 105mΩ@V_{GS}= -10V
- -60V/-6A,$R_{DS(ON)}$= 115mΩ@V_{GS}= -4.5V

Pin Description (DFN3X3-8L)

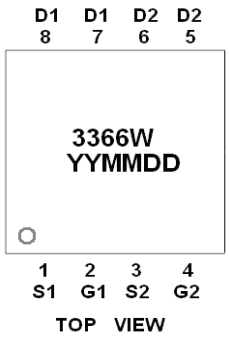




N-Channel MOSFET



P-Channel MOSFET



Application

- DC/DC Conversion
- Load Switch
- DC FAN

Pin Define

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFC3366WFN338RG	3366W YYMMDD	DFN3X3-8L	Tape & Reel	5000 EA

※ YY year code
※ MM month code
※ DD date code
※ AFC3366WFN338RG : 13” Tape & Reel ; Pb- Free ; Halogen- Free

Absolute Maximum Ratings (N-Channel)

(T_A=25℃ Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	60	V
Gate –Source Voltage		V_{GSS}	±20	V
Continuous Drain Current(T_J=150℃)	T_A=25℃	I_D	12	A
	T_A=70℃		10	
Pulsed Drain Current		I_{DM}	30	A
Continuous Source Current(Diode Conduction)		I_S	10	A
Power Dissipation	T_A=25℃	P_D	2	W
	T_A=70℃		1.5	
Operating Junction Temperature		T_J	150	℃
Storage Temperature Range		T_{STG}	-55/150	℃
Thermal Resistance-Junction to Ambient		$R_{\theta JA}$	56	℃/W

Electrical Characteristics (N-Channel)

(T_A=25℃ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	60			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	0.8		2.5	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=48V,V_{GS}=0V			1	uA
		V_{DS}=48V,V_{GS}=0V T_J=85℃			5	
On-State Drain Current	$I_{D(on)}$	V_{DS}≧5V,V_{GS}=4.5V	30			A
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=10V,I_D=12A		40	48	mΩ
		V_{GS}=4.5V,I_D=10A		44	54	
Forward Transconductance	g_{FS}	V_{DS}=15V,I_D=5.3A		24		S
Diode Forward Voltage	V_{SD}	I_S=2.0A,V_{GS}=0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=30V,V_{GS}=5V I_D≡5.6A		10	15	nC
Gate-Source Charge	Q_{gs}			3.5		
Gate-Drain Charge	Q_{gd}			3.6		
Input Capacitance	C_{iss}	V_{DS}=30V,V_{GS}=0V f=1MHz		890		pF
Output Capacitance	C_{oss}			85		
Reverse Transfer Capacitance	C_{rss}			48		
Turn-On Time	$t_{d(on)}$	V_{DD}=30V,R_L=6.8Ω I_D≡5.0A,V_{GEN}=4.5V R_G=6Ω		10	15	ns
	t_r			12	20	
Turn-Off Time	$t_{d(off)}$			25	35	
	t_f			10	15	

Absolute Maximum Ratings (P-Channel)

(T_A=25℃ Unless otherwise noted)

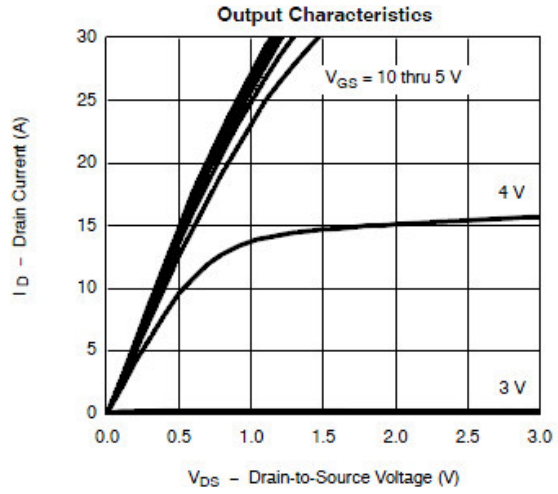
Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	-60	V
Gate –Source Voltage		V_{GSS}	±20	V
Continuous Drain Current(TJ=150℃)	T_A=25℃	I_D	-8.0	A
	T_A=70℃		-6.0	
Pulsed Drain Current		I_{DM}	-30	A
Continuous Source Current(Diode Conduction)		I_S	-10	A
Power Dissipation	T_A=25℃	P_D	1.8	W
	T_A=70℃		1.2	
Operating Junction Temperature		T_J	150	℃
Storage Temperature Range		T_{STG}	-55/150	℃
Thermal Resistance-Junction to Ambient		$R_{\theta JA}$	62.5	℃/W

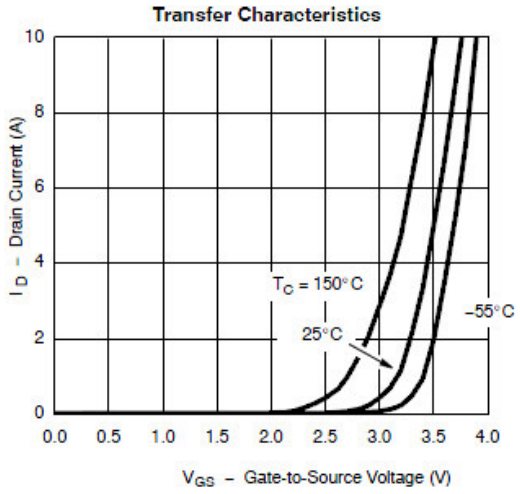
Electrical Characteristics (P-Channel)

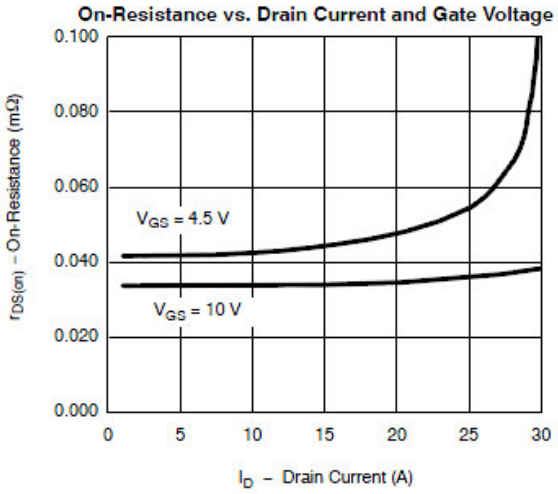
(T_A=25℃ Unless otherwise noted)

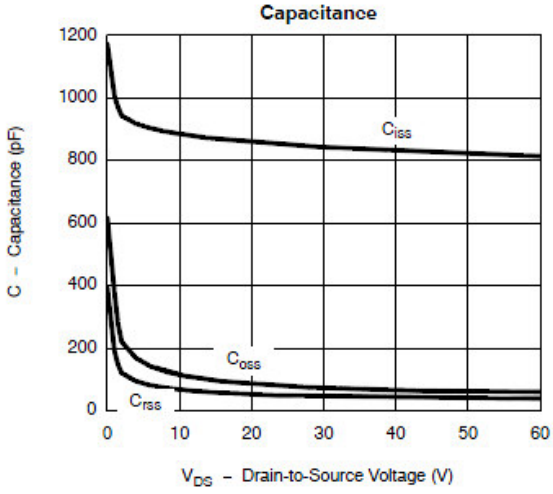
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D= -250uA	-60			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D= -250uA	-0.8		-2.5	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}= ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}= -48V,V_{GS}=0V			-1	uA
		V_{DS}= -48V,V_{GS}=0V T_J=85℃			-20	
On-State Drain Current	$I_{D(on)}$	V_{DS}≧ -5V,V_{GS}= -10V	-20			A
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = -10V,I_D=-8.0A		96	105	mΩ
		V_{GS} = -4.5V,I_D=-6.0A		104	115	
Forward Transconductance	g_{FS}	V_{DS}= -15V,I_D= -3.2A		12		S
Diode Forward Voltage	V_{SD}	I_S= -2A,V_{GS}=0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=-30V,V_{GS}=-10V I_D= -4.0A		12	20	nC
Gate-Source Charge	Q_{gs}			2.5		
Gate-Drain Charge	Q_{gd}			3.5		
Input Capacitance	C_{iss}	V_{DS}=-30V,V_{GS}=0V f=1MHz		900		pF
Output Capacitance	C_{oss}			90		
Reverse Transfer Capacitance	C_{rss}			40		
Turn-On Time	$t_{d(on)}$	V_{DD}=-30V,R_L=7.5Ω I_D≡-3.0A,V_{GEN}=-10V R_G=3Ω		10	20	ns
	t_r			6	10	
Turn-Off Time	$t_{d(off)}$			30	45	
	t_f			12	25	

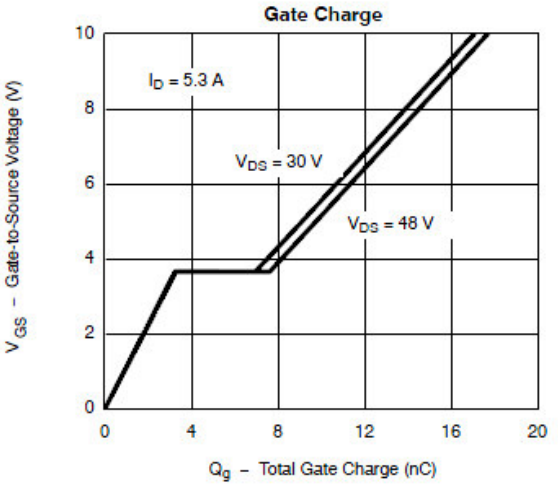
Typical Characteristics (N-Channel)

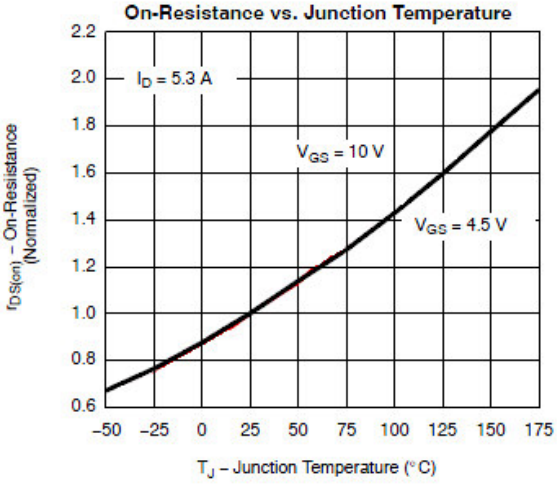




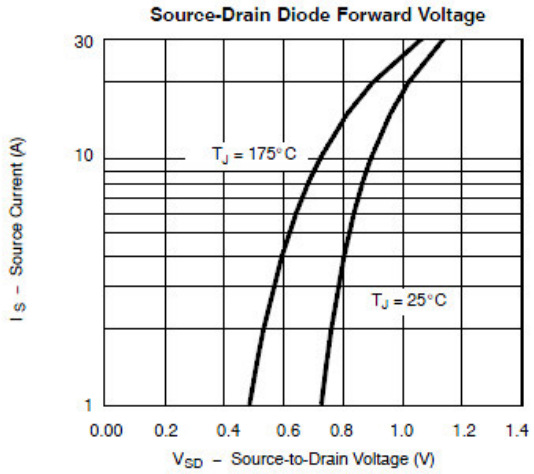


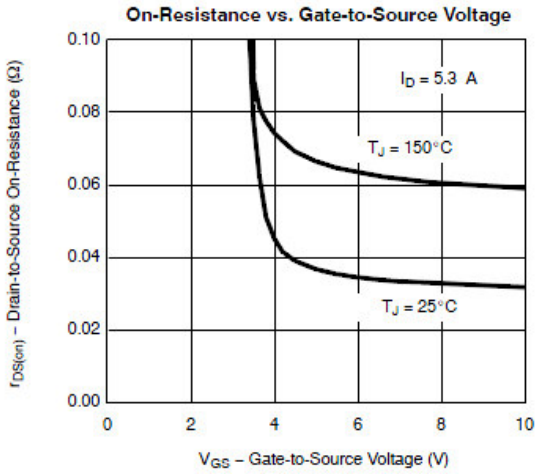


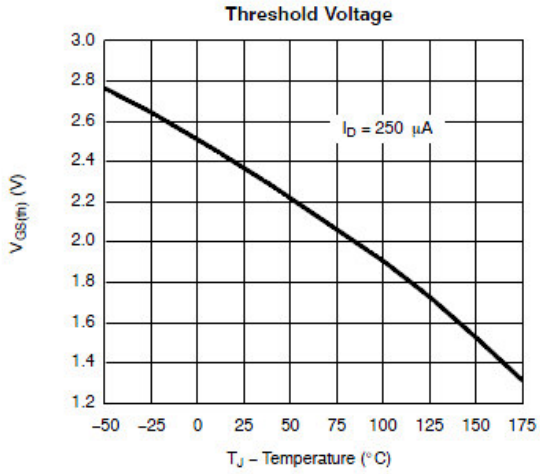


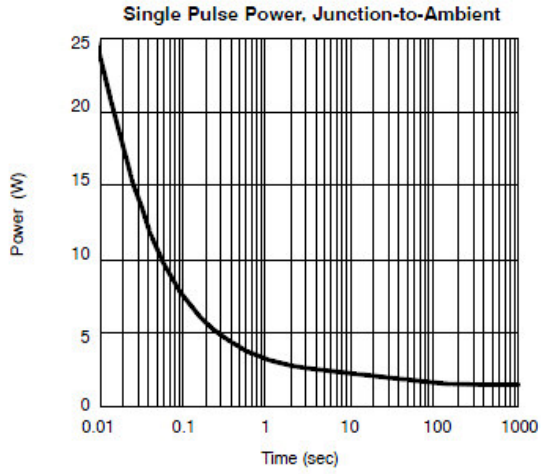


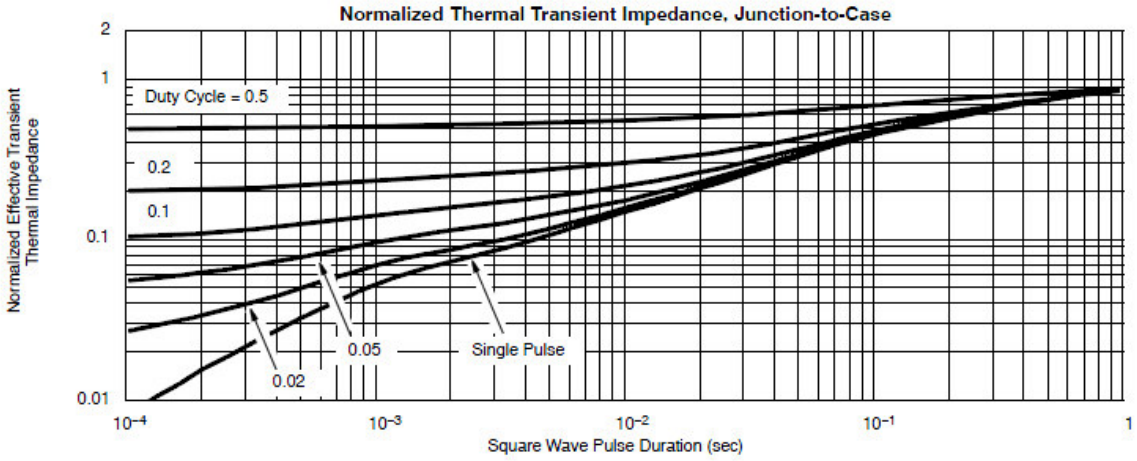
Typical Characteristics (N-Channel)



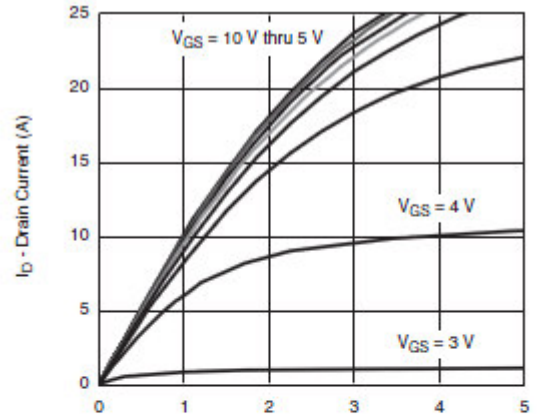




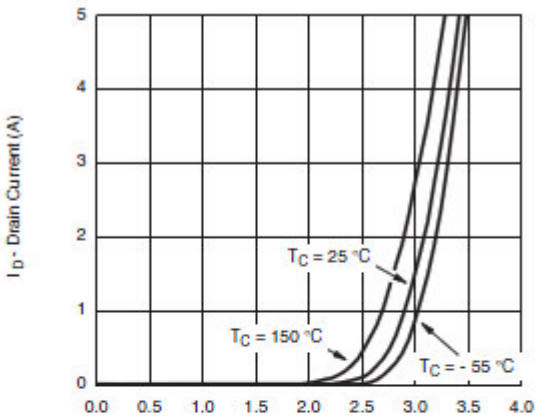




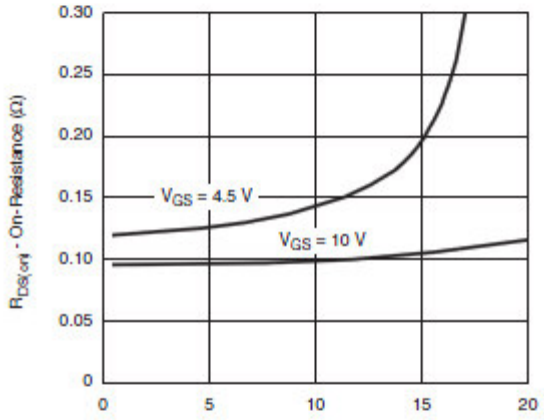
Typical Characteristics (P-Channel)



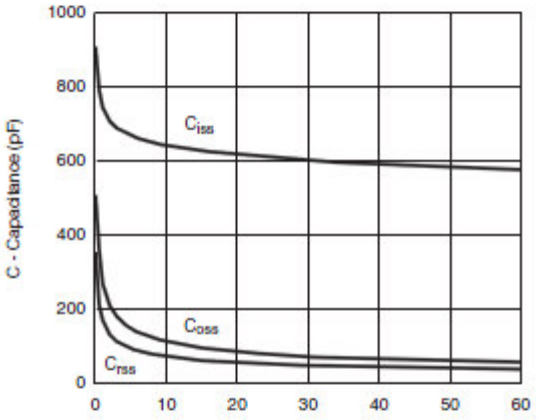
Output Characteristics



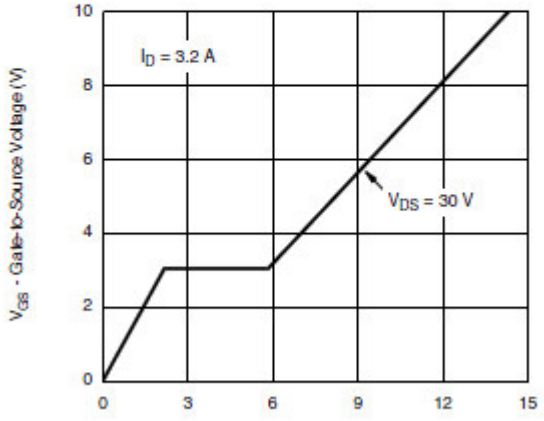
Transfer Characteristics



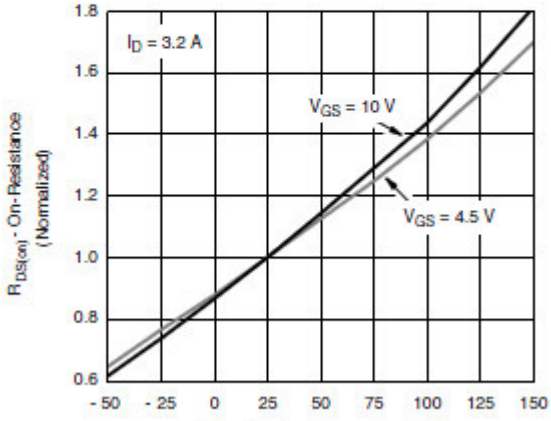
On-Resistance vs. Drain Current



Capacitance

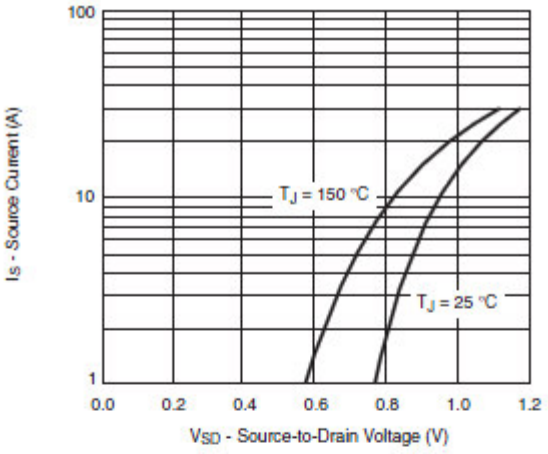


Gate Charge

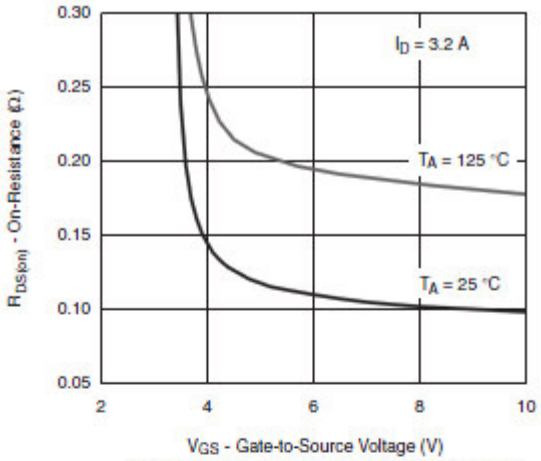


On-Resistance vs. Junction Temperature

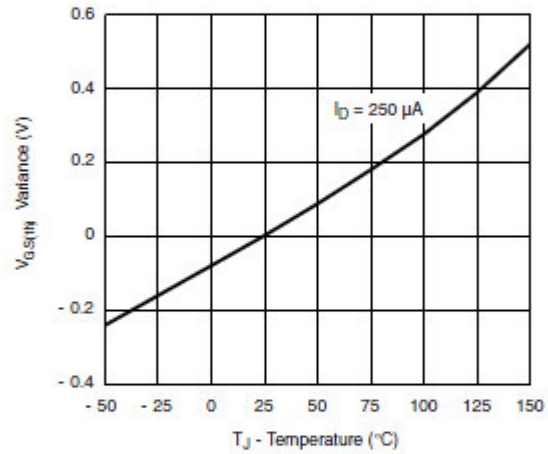
Typical Characteristics (P-Channel)



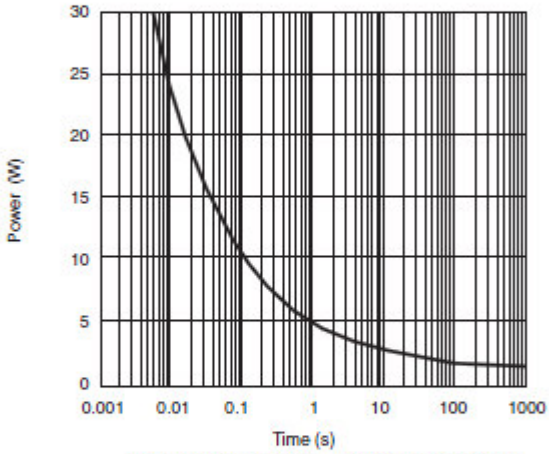
Source-Drain Diode Forward Voltage



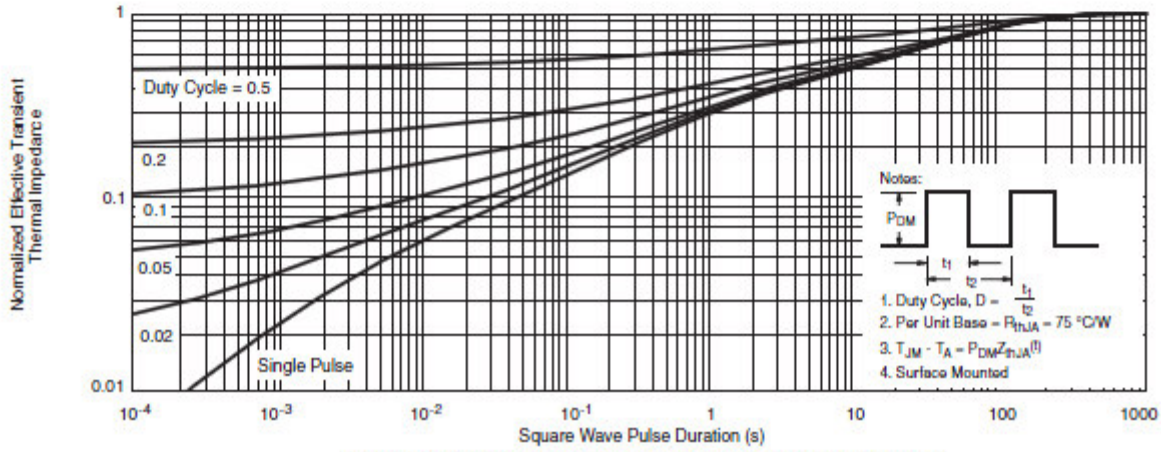
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



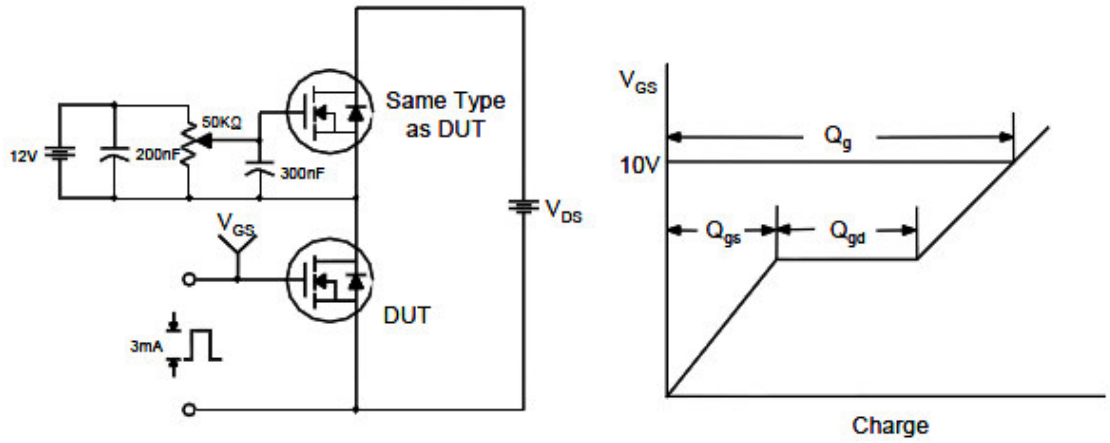
Single Pulse Power, Junction-to-Ambient



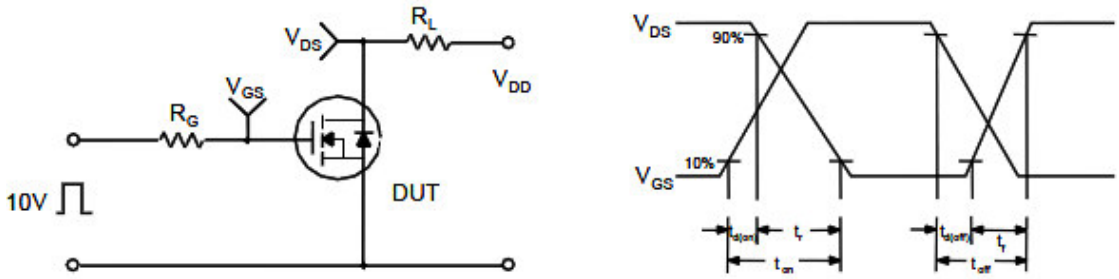
Normalized Thermal Transient Impedance, Junction-to-Ambient

Typical Characteristics

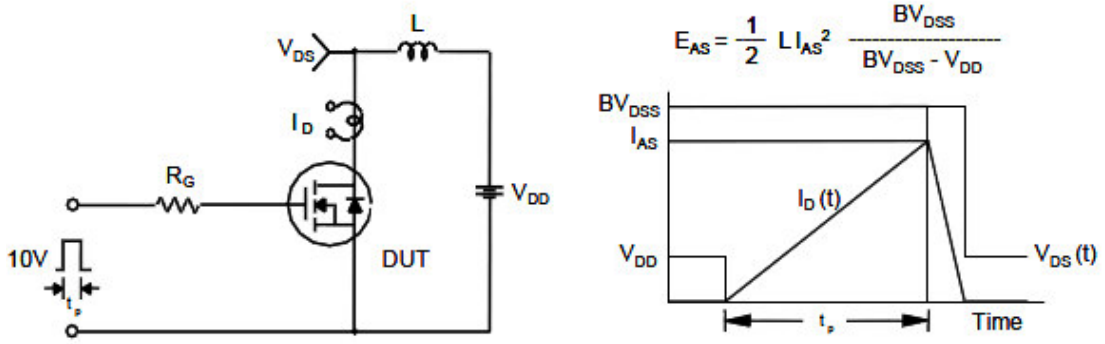
Gate Charge Test Circuit & Waveform



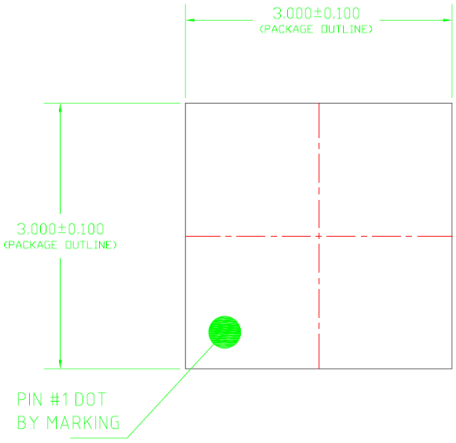
Resistive Switching Test Circuit & Waveforms



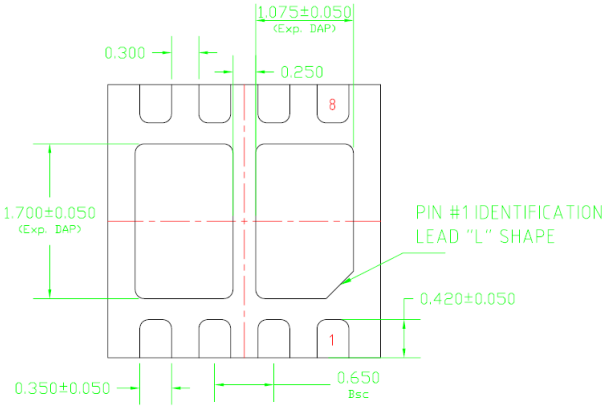
Unclamped Inductive Switching Test Circuit & Waveforms



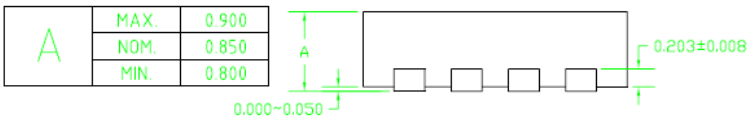
Package Information (DFN3X3-8L)



TOP VIEW



BOTTOM VIEW



SIDE VIEW

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